ASSOCIATION CONNECTING ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® international and Pa	IPC. Bannockl	burn, Illinois, A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities are an entities are an entities and the declaration entities are an entits are an entities are an entits are an entities are an entities	on of the su	bstances v all lower	vithin the manufactu level materials for v	rer listed in the rest of the	tem. Note: nanufacture	if the item is an as r has engineering	sembly with low responsibility.	
				Form Type Distribute	<ul> <li>Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information</li> </ul>									
Supplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority				Respon	Response Date*			
nsemi										2025-07-01				
Contact Name	Name Title - Contact				]	Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Enviro Compl			ro Compliance	Compliance		NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represent			entative		Phone - Representative*			Email - Representative*						
Product-Env-Stewards Product			duct Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type	
	NCP810	NCP81071BMNTXG Dual Low-Side Driv		Driver		2025-07-01		PI	PH1		19.59	mg	Each	
Ianufacturing Proccess Informa	ntion													
Terminal Plating / Grid Array M	laterial 7	ial Terminal Base Alloy J-		J-STD-020 MSI	L Rating	Peak Process Body T		Temperature Max Time at Peak		c Tempera	ture Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	secoi	nds 3				
omments														
vel 1 - maximum time at peak temperat	ure during so	dering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or en [F] Optionally enter the positive (+) a				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.73	mg	Supplier	Silicon (Si)	7440-21-3		0.73	mg
Die Attach	0.17	mg	Supplier	Silver (Ag)	7440-22-4		0.1275	mg
			Supplier	Epoxy resins	129915-35-1		0.0425	mg
Lead Frame	7.11	mg	Supplier	Silver (Ag)	7440-22-4		0.0711	mg
			Supplier	Tin (Sn)	7440-31-5		0.0178	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0156	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0178	mg
			Supplier	Copper (Cu)	7440-50-8		6.9877	mg
Mold Compound-Black	11.17	mg		Epoxy resin	proprietary data		0.525	mg
			Supplier	Phenol Resin	Proprietary Data		0.525	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0112	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.1088	mg
Plating	0.36	mg	Supplier	Tin (Sn)	7440-31-5		0.36	mg
Wire Bond - Cu	0.05	mg	Supplier	Copper (Cu)	7440-50-8		0.05	mg